

CBR-SMD RF COG, Ceramic, 18 pF, 5%, 100 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



| Dimensions |                     |
|------------|---------------------|
| Chip Size  | 0402                |
| L          | 1mm +/-0.05mm       |
| W          | 0.5mm +/-0.05mm     |
| T          | 0.5mm +/-0.05mm     |
| B          | 0.25mm +0.05/-0.1mm |

| Packaging Specifications |                          |
|--------------------------|--------------------------|
| Packaging:               | T&R, 180mm, Plastic Tape |
| Packaging Quantity:      | 10000                    |

| General Information |  |
|---------------------|--|
| Series:             | CBR-SMD RF COG                                 |
| Style:              | SMD Chip                                       |
| Description:        | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features:           | Ultra High Q, Low ESR, Class I                 |
| RoHS:               | Yes  |
| Termination:        | Tin  |
| Marking:            | No   |
| AEC-Q200:           | No   |
| Component Weight:   | 1400 ug  |
| Notes:              | Solder Reflow Only.                            |
| Shelf Life:         | 78 Weeks                                       |
| MSL:                | 1  |

| Specifications                   |                     |
|----------------------------------|---------------------|
| Capacitance:                     | 18 pF               |
| Capacitance Tolerance:           | 5%                  |
| Voltage DC:                      | 100 VDC             |
| Dielectric Withstanding Voltage: | 250 VDC             |
| Temperature Range:               | -55/+125°C          |
| Temperature Coefficient:         | COG                 |
| Dissipation Factor:              | 0.132%              |
| Aging Rate:                      | 0% Loss/Decade Hour |
| Insulation Resistance:           | 10 GOhms            |
| Quality Factor:                  | 760                 |